

N-Channel 60 V (D-S) MOSFET

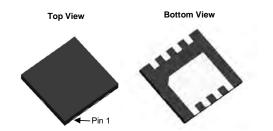
| PRODUCT SUMMARY | | | | |
|---------------------|----------------------------------|---------------------------------|--|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) ^a | | |
| 60 | 0.010 at V _{GS} = 10 V | 15 | | |
| 00 | 0.013 at V _{GS} = 4.5 V | 12 | | |

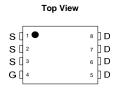
FEATURES

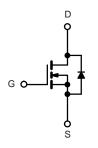
- 175 °C Junction Temperature
- TrenchFET[®] Power MOSFET
- Material categorization:











N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | | |
|--|-------------------------|-----------------------------------|--------------------------------------|----|--|--|
| Parameter | Symbol | Limit | Unit | | | |
| Gate-Source Voltage | | V_{GS} | ± 20 | V | | |
| 0 1 0 1 T 175 101h | T _C = 25 °C | L | 15 | | | |
| Continuous Drain Current (T _J = 175 °C) ^b | T _C = 100 °C | - I _D | 13 ^a | | | |
| Pulsed Drain Current | I _{DM} | 100 | Α | | | |
| Continuous Source Current (Diode Conduction) | I _S | 50 ^a | | | | |
| Avalanche Current | I _{AS} | 50 | | | | |
| Single Avalanche Energy (Duty Cycle ≤ 1 %) | L = 0.1 mH | E _{AS} | 125 | mJ | | |
| Maximum Power Dissipation | T _C = 25 °C | P _D | 136 | W | | |
| Maximum Fower Dissipation | T _A = 25 °C | ' D | 3 ^b , 8.3 ^{b, c} | | | |
| Operating Junction and Storage Temperature Range | • | T _J , T _{stg} | - 55 to 175 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maniana lugation to Ambienta | t ≤ 10 sec | R _{thJA} | 15 | 18 | °C/W | |
| Maximum Junction-to-Ambient ^a | Steady State | | 40 | 50 | | |
| Maximum Junction-to-Case | | R _{thJC} | 0.85 | 1.1 | | |

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- $c.\ t \leq 10\ s.$

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| SPECIFICATIONS (T _J = 25 °C, unless otherwise noted) | | | | | | | |
|--|---------------------|--|----|-------|-------|------|--|
| Parameter | Symbol | nbol Test Conditions Min. | | Typ.a | Max. | Unit | |
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 60 | | | V | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ | | 2 | 3 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| | | V _{DS} = 60 V, V _{GS} = 0 V | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125 °C | | | 50 | μΑ | |
| | | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$ | | | 250 | 1 | |
| On-State Drain Current ^b | I _{D(on)} | $V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 60 | | | Α | |
| | | V _{GS} = 10 V, I _D = 20 A | | 0.010 | | | |
| Davis Course Or Otata Basistanah | P | V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C | | 0.016 | | Ω | |
| Drain-Source On-State Resistance ^b | R _{DS(on)} | V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C | | 0.020 | | | |
| | | V _{GS} = 4.5 V, I _D = 15 A | | 0.013 | | | |
| Forward Transconductance ^b | 9 _{fs} | V _{DS} = 15 V, I _D = 20 A | | 60 | | S | |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | | | 2650 | | | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | | 470 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 225 | | 1 | |
| Total Gate Charge ^c | Q_g | | | 47 | 70 | | |
| Gate-Source Charge ^c | Q_{gs} | $V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$ | | 10 | | nC | |
| Gate-Drain Charge ^c | Q_{gd} | | | 12 | | | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 10 | 20 | | |
| Rise Time ^c | t _r | $V_{DD} = 30 \text{ V}, R_{L} = 0.6 \Omega$ | | 15 | 25 | no | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$ | | 35 | 50 | ns | |
| Fall Time ^c | t _f | 1 – | | 20 | 30 | | |
| Source-Drain Diode Ratings and Cha | aracteristics (| T _C = 25 °C) | | | | | |
| Pulsed Current | I _{SM} | | | | 60 | Α | |
| Diode Forward Voltage | V_{SD} | $I_F = 20 \text{ A}, V_{GS} = 0 \text{ V}$ | | 1 | 1.5 | V | |
| Reverse Recovery Time | t _{rr} | I _F = 20 A, di/dt = 100 A/μs | | 45 | 100 | ns | |

Notes:

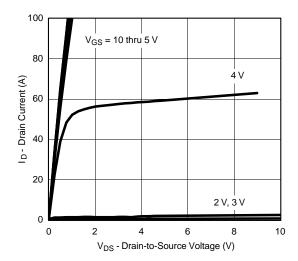
- a. For design aid only; not subject to production testing.
- b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

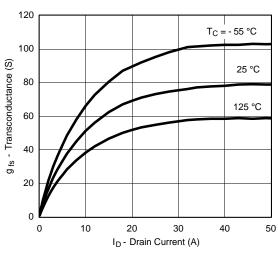
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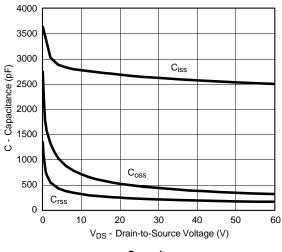
TYPICAL CHARACTERISTICS (25 °C unless noted)



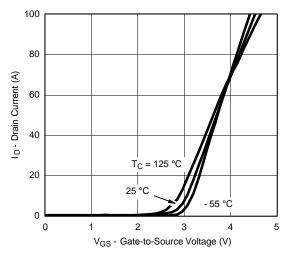
Output Characteristics



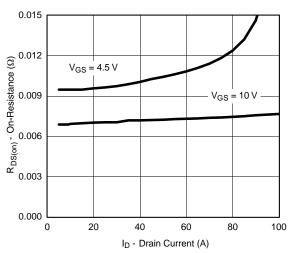
Transconductance



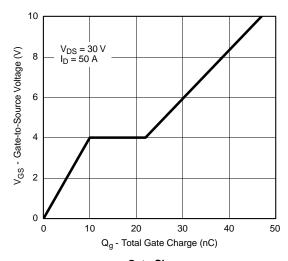
Capacitance



Transfer Characteristics



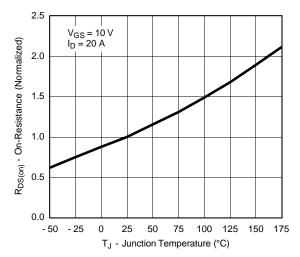
On-Resistance vs. Drain Current



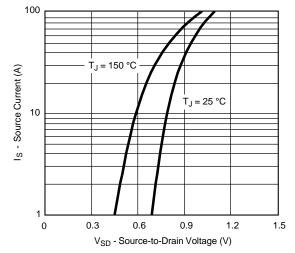
Gate Charge



TYPICAL CHARACTERISTICS (25 °C unless noted)



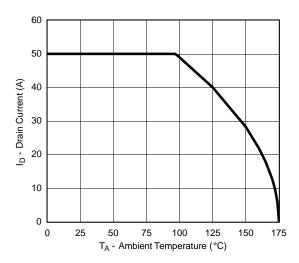
On-Resistance vs. Junction Temperature

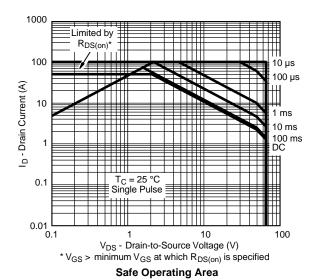


Source-Drain Diode Forward Voltage

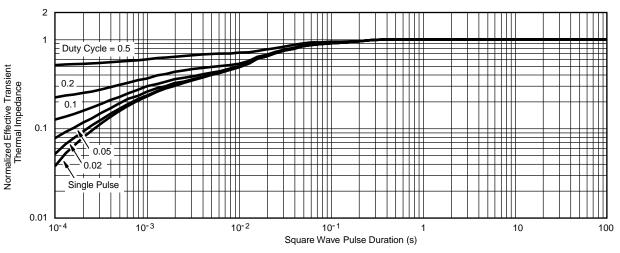


THERMAL RATINGS





Maximum Drain Current vs. Ambient Temperature

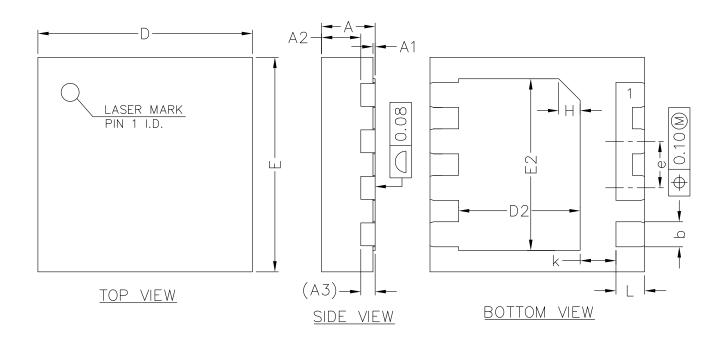


Normalized Thermal Transient Impedance, Junction-to-Case

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COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

| SYMBOL | MIN | NOM | MAX | |
|--------|---------|------|------|--|
| Α | 0.70 | 0.75 | 0.80 | |
| A1 | 0.00 | 0.02 | 0.05 | |
| A2 | 0.50 | 0.55 | 0.60 | |
| А3 | 0.20REF | | | |
| Ь | 0.30 | 0.35 | 0.40 | |
| D | 2.90 | 3.00 | 3.10 | |
| E | 2.90 | 3.00 | 3.10 | |
| D2 | 1.60 | 1.70 | 1.80 | |
| E2 | 2.30 | 2.40 | 2.50 | |
| е | 0.55 | 0.65 | 0.75 | |
| K | 0.40 | 0.50 | 0.60 | |
| L | 0.35 | 0.40 | 0.45 | |

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WMJ80N60C4 BXP2N20L BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR DMNH15H110SK3-13
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